

High Tg / Ultra Low Loss / Halogen Free EM-890K / EM-89BK

- Ultra low Df and excellent electrical performance
- Excellent CAF resistance
- Multiple lamination and high thermal reliability applications
- For high speed Ethernet, network, 5G, Antenna applications

Basic Laminate Property

Property	Item		IPC-TM-650	Test Condition	Unit	Typical Value
Thermal	Tg		2.4.25	DSC	°C	N/A
			2.4.24	TMA	°C	170
			2.4.24.4	DMA	°C	205
	CTE, X/Y-axis		2.4.24.5	< Tg, TMA	ppm/°C	12/13
	CTE, Z-axis		2.4.24	< Tg, TMA	ppm/°C	45~50
				> Tg, TMA	ppm/°C	185~205
	Z-axis Expansion		2.4.24	50~260℃	%	2.2
	Td		2.4.24.6	TGA (5% W.L)	°C	430
	T288		2.4.24.1	Clad	Min	>60
				Etched	Min	>60
Electrical	Dk (R/C: 55/70%)	1 GHz	2.5.5.9	C-24/23/50	-	3.1/2.9
		10 GHz	SPDR			3.0/2.8
			Cavity Resonator			3.0/2.8
	Df (R/C: 55/70%)	1 GHz	2.5.5.9	C-24/23/50	-	0.0019/0.0018
		10 GHz	SPDR			0.0022/0.0021
			Cavity Resonator			0.0025/0.0024
Physical	Water Absorption		2.6.2.1	E-1/105+D-24/23	%	0.07
	Peel Strength (HVLP)	H oz	2.4.8	As Received	lb/in	4.5
	Flexural Warp Strength Fill		2.4.4	As Received	MPa	430-470
						410-450
	Flame Resistance		UL-94	A & E-24/125	-	V-0

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